

### Data Sheet

### January 30, 2007

## FN6427.0

## Low Jitter Clock Generators for Set-Top Box

The ISL14011 series of devices are general purpose integrated Clock Synthesizers and Generators suited for consumer applications such as Set-top Box, and various other consumer applications.

The selectable reference input accepts 30MHz signal either from crystal or an external source. It is specified to operate with a nominal 3.3V supply and is offered in 16 Ld QFN package.

Contact Factory for other output frequency options.

## **Ordering Information**

PART	PART	TEMP.	PACKAGE	PKG.	
NUMBER	MARKING	RANGE (°C)		DWG. #	
ISL14011IRZ*	11IZ	-40 to +85	16 Ld QFN	L16.3x3	

\*Add "-T" suffix for tape and reel.

NOTE: Intersil Pb-free plus anneal products employ special Pb-free material sets; molding compounds/die attach materials and 100% matte tin plate termination finish, which are RoHS compliant and compatible with both SnPb and Pb-free soldering operations. Intersil Pb-free products are MSL classified at Pb-free peak reflow temperatures that meet or exceed the Pb-free requirements of IPC/JEDEC J STD-020.

## Selection Table

PART OPTIONS	INPUT FREQUENCY	NUMBER OF OUTPUTS	OUTPUT FREQUENCY	PACKAGE
ISL14011	30MHz	4 LVTTL	25, 30, 24, 27	16 Ld QFN

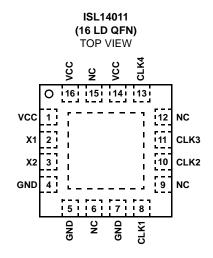
## Features

- LVTTL Outputs
- · Selectable Crystal or Ref. Clock for Inputs
- Period Jitter ~50ps RMS
- Single Supply; 3.3V nominal
- Extended Temperature Range: -40°C to +85°C
- Available in small foot print package
  16 Ld QFN 3mmx3mm
- · Pb-Free plus anneal available (RoHS Compliant)

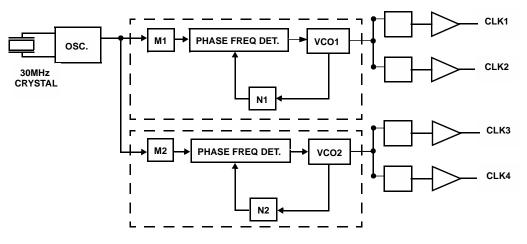
## Applications

Set-Top Boxes

## Pinout



## Functional Block Diagram



## **Pin Description**

16 LD QFN	SYMBOLS	PIN DESCRIPTION
1,14,16	VCC	Supply Voltage
2	X1	The X1 pin is the terminal 1 of an external 30MHz crystal. This pin is grounded for external CK input.
3	X2	The X2 pin is the terminal 2 of external 30MHz crystal, or external clock input.
4, 5, 7	GND	Ground
8	CLK1	CLK1 Output: 25MHz
10	CLK2	CLK2 Output: 30MHz
11	CLK3	CLK3 Output: 24MHz
13	CLK4	CLK4 Output: 27MHz
6, 9,12,15	NC	No Connect

### **Absolute Maximum Ratings**

Voltage on VCC, CLK pins (respect to Gnd)0.3V to 4.0V
Voltage on X1, X2 pins (respect to Gnd)0.3V to 2.5V
ESD Rating
MIL STD-883, Method 3014>±5kV
Machine Model>500V

### **Thermal Information**

Thermal Resistance (Typical, Note 1)	$\theta_{JA}$ (°C/W)	$\theta_{JC}$ (°C/W)
16 Ld QFN Package	59	11.5
Storage Temperature		<sup>o</sup> C to +150 <sup>o</sup> C
Lead Temperature (Soldering 10s)		+300⁰C

CAUTION: Stresses above those listed in "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress only rating and operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied.

### NOTE:

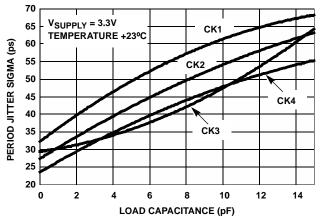
 θ<sub>JA</sub> is measured in free air with the component mounted on a high effective thermal conductivity test board with "direct attach" features. See Tech Brief TB379.

# **DC Electrical Specifications** $V_{CC} = 3.3V \pm 10\%$ , $T_A = -40^{\circ}C$ to +85°C, Typical values are at $T_A = +25^{\circ}C$ and $V_{CC} = 3.3V$ , Unless otherwise noted

SYMBOL	SYMBOL	CONDITIONS	MIN	ТҮР	MAX	UNIT
Supply Voltage	V <sub>CC</sub>	Supply Voltage	3.0	3.3	3.6	V
Supply Current	Icc	Supply Current CL = 5pF on all outputs		11	15	mA
CLOCK INPUT X <sub>2</sub> (X <sub>1</sub> GROUND	ED) FOR EXTERN	IAL CLOCK MODE			1	I
Input High Level	VIH		1.5		2.4	V
Input Level Low	VIL				0.5	V
Input Current	IIL, IIH	V <sub>X2</sub> to Ground		0.5		mA
CLOCK OUTPUTS (CLK)						
Output High Level	V <sub>OH</sub>	I <sub>OH</sub> = -100μA	V <sub>CC</sub> -0.2			V
		I <sub>OH</sub> = -4mA	2.4			V
		I <sub>OH</sub> = -6mA	2.1			V
Output Low Level	V <sub>OL</sub>	I <sub>OL</sub> = 100µA			0.2	V
		I <sub>OL</sub> = 4mA			0.4	V
		I <sub>OL</sub> = 6mA			0.75	V
Output Short Circuit Current	IOSC	CLK = V <sub>CC</sub> or Gnd	6	13	30	mA

### AC Electrical Specifications CL= 5pF on all outputs

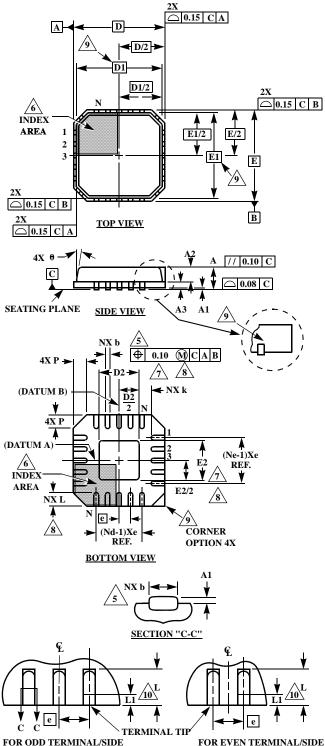
SYMBOL	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNIT	
Crystal Frequency	fin			30		MHz	
CLOCK OUTPUTS	CLOCK OUTPUTS						
Rise Time	<sup>t</sup> R	20% to 80% V <sub>CC</sub>		1.8		ns	
Fall Time	t <sub>F</sub>	80% to 20% V <sub>CC</sub>		1.8		ns	
Duty Cycle			40		60	%	
Period Jitter	JP	RMS		50		ps	
Power Up Time	t <sub>PO</sub>	V <sub>CC</sub> >2.7V		2		ms	



Typical Performance Curves (Period Jitter)

FIGURE 1. STANDARD DEVIATION vs LOAD CAPACITANCE





### L16.3x3

16 LEAD QUAD FLAT NO-LEAD PLASTIC PACKAGE

	MILLIMETERS			
SYMBOL	MIN	NOMINAL	MAX	NOTES
А	0.80	0.90	1.00	-
A1	-	-	0.05	-
A2	-	-	1.00	9
A3		0.20 REF		9
b	0.18	0.23	0.30	5, 8
D		3.00 BSC		-
D1		2.75 BSC		9
D2	1.35	1.50	1.65	7, 8, 10
Е	3.00 BSC			-
E1	2.75 BSC			9
E2	1.35	1.50	1.65	7, 8, 10
е	0.50 BSC			-
k	0.20	-	-	-
L	0.30	0.40	0.50	8
Ν	16			2
Nd	4			3
Ne	4			3
Р	-	-	0.60	9
θ	-	-	12	9
				Rev. 1 6/04

#### NOTES:

- 1. Dimensioning and tolerancing conform to ASME Y14.5-1994.
- 2. N is the number of terminals.
- 3. Nd and Ne refer to the number of terminals on each D and E.
- 4. All dimensions are in millimeters. Angles are in degrees.
- 5. Dimension b applies to the metallized terminal and is measured between 0.15mm and 0.30mm from the terminal tip.
- 6. The configuration of the pin #1 identifier is optional, but must be located within the zone indicated. The pin #1 identifier may be either a mold or mark feature.
- 7. Dimensions D2 and E2 are for the exposed pads which provide improved electrical and thermal performance.
- Nominal dimensions are provided to assist with PCB Land Pattern Design efforts, see Intersil Technical Brief TB389.
- 9. Features and dimensions A2, A3, D1, E1, P & 0 are present when Anvil singulation method is used and not present for saw singulation.
- 10. Compliant to JEDEC MO-220VEED-2 Issue C, except for the E2 and D2 MAX dimension.

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